OPTIMUM SNUBBERS FOR POWER SEMICONDUCTORS

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Abstract

It is generally necessary to connect an R-C snubber across a power rectifier or thyristor to absorb the energy associated with the recovery current of the device and limit the resulting voltage spike and rate of rise dv/dt. For a given snubber capacitance, it is shown that there is an optimum damping resistance which minimizes the peak voltage but a lower resistance is required to minimize the average dv/dt to the peak. Design procedures are derived for selecting the capacitance and optimum resistance to limit the peak voltage or dv/dt to specified values. The device recovery current is trapped in circuit inductance and its energy must be dissipated, while the snubber produces additional losses as the price of performing its limiting function.

General Equations of Recovery Voltage Transient

For analysis of the recovery voltage transient appearing across a semiconductor rectifier diode or thyristor device, a power converter can usually be reduced to an equivalent circuit of the form shown in Fig. 1. A voltage E, which can be assumed steady throughout the transient, is applied to a series R-C-L circuit. The voltage e across the snubber resistance and capacitance in series appears as recovery voltage on the semiconductor device. The initial capacitor voltage is zero, but an initial current I is present in the circuit. This is the peak reverse recovery current in the device, which becomes established in the inductance L and is forced to transfer to the R-C path when the device blocks. Blocking is assumed to occur in a short interval, which is certainly the case for snap-off diodes and a reasonable approximation for most other devices. Time zero of the transient is the instant when the device blocks. The initial value of e is IR. An ideal recovery transient is shown in Fig. 2.

The peak recovery current I for a given device is a function of temperature, the previous forward current before application of the commutating voltage E, and the rate di/dt which is equal to E/L. Typical or maximum values of recovery current (or the recovered charge, from which the current can easily be calculated) are included in many device specifications as functions of these parameters [1].

The general Laplace transforms for the current i and the voltage e are

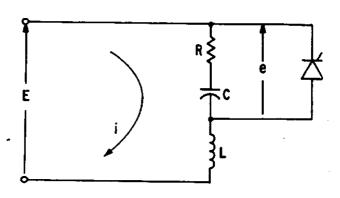


Fig. 1 Equivalent Circuit of Snubber

$$i(s) = \frac{\frac{E}{L} + sI}{s^2 + \frac{R}{L}s + \frac{1}{LC}}$$
 (1)

$$e(s) = -\frac{s(E-RI) - \frac{I}{C}}{s^2 + \frac{R}{I} + \frac{1}{I} + \frac{E}{s}} + \frac{E}{s}$$
 (2)

The general solutions of these equations will now be presented. The parameters ω_0 and α are defined as follows.

Un-damped natural frequency (radians/sec):

$$\omega_{o} = \frac{1}{\sqrt{LC}}$$
 (3)

Decrement factor:

$$\alpha = \frac{R}{2L} \tag{4}$$

For designing the snubber circuit, it is convenient to express the equations in terms of the following normalized parameters.

Initial current factor:

$$X = \frac{1}{E} \sqrt{\frac{L}{C}}$$
 (5)

Damping factor:

$$\zeta = \frac{R}{2\sqrt{L/C}} = \alpha/\omega_0 \tag{6}$$

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Note that
$$\chi^{2} = \frac{\frac{1}{2} LI^{2}}{\frac{1}{2} CE^{2}} = \frac{\text{Initial energy in inductance}}{\text{Final energy in capacitor}}$$

Case I Under-damped condition, 7 < 1

This is the case of most practical importance, since it includes the optimum design of the snubber circuit. The angular frequency of the damped oscillations is given by

$$\omega = \sqrt{\omega_o^2 - \alpha^2} = \omega_o \sqrt{1 - \zeta^2}$$
 (8)

The inverse transform of (2) yields

$$e = E - (E - RI)(\cos \omega t - \omega \sin \omega t) e^{-\alpha t}$$

$$+ \frac{I}{C\omega} \sin \omega t e^{-\alpha t}$$
(9)

Differentiating (9)

$$de/dt = (E - RI)(2 \alpha \cos \omega t + \frac{\omega^2 - \alpha^2}{\omega} \sin \omega t) e^{-\alpha t} + \frac{I}{C} (\cos \omega t - \frac{\alpha}{\omega} \sin \omega t) e^{-\alpha t}$$
(10)

The initial voltage and slope can be deduced by inspection of the circuit Fig. 1, or obtained by setting t = 0 in (9) and (10). Note that the result is the same for critical or over-damping.

$$\left(\frac{e}{E}\right)_{G} = \frac{RI}{E} = 2\zeta_{X}$$
 (11)

$$\left(\frac{de}{dt}\right)_{\Omega} = (E - RI) 2 \alpha + \frac{I}{C}$$
 (12)

$$= \frac{(E - RI)R}{L} + \frac{I}{C}$$
 (13)

=
$$Ew_0$$
 $(2\zeta + 4\zeta^2\chi + \chi)$ (14)

If this initial slope is not positive, then the initial recovery voltage given by (11) is the maximum. However, if

$$2\zeta - 4\zeta^2 \chi + \chi > 0$$
 (15)

or
$$\zeta < \frac{1 + \sqrt{1 + 4_{\chi}^2}}{4_{\chi}}$$
 (16)

the slope is positive and the recovery voltage rises to a peak at a time \mathbf{t}_1 which can be obtained by setting (10) equal to zero, yielding

$$\tan \omega t_1 = -\frac{(E - RI) 2\alpha + \frac{I}{C}}{(E - RI) \frac{\omega^2 - \alpha^2}{\omega} - \frac{I\alpha}{C\alpha}}$$
(17)

$$= -\frac{(2\zeta - 4\zeta^2\chi + \chi)\sqrt{1 - \zeta^2}}{1 - 3\zeta\chi - 2\zeta^2 + 4\zeta^3\chi}$$
 (18)

$$t_1 = \frac{1}{\omega} \tan^{-1} f(\zeta, \chi)$$
 (20)

$$= \frac{\tan^{-1} f(\zeta, \chi)}{\omega_0 \sqrt{1 - \zeta^2}}$$
 (21)

where the angle is in the first or second quadrant, depending upon whether the function $f(\zeta, \chi)$ is positive or negative respectively.

Substituting the value of $\mathbf{t_1}$ from (21) into (9), the value $\mathbf{E_1}$ of the peak recovery voltage is obtained

$$E_{1} = E + e^{-\alpha t_{1}} \sqrt{(E - RI)^{2} + \frac{2\alpha(E - IR) I}{\omega_{o}^{2} C}}$$

$$\frac{I^{2}}{\omega_{o}^{2} C^{2}}$$
(22)

The normalized peak voltage can be reduced to a function of ζ and χ , defined as $p(\zeta, \chi)$

$$p(\zeta, \chi) = \frac{E_1}{E} = 1 + \exp\left\{-\frac{\zeta}{\sqrt{1-\zeta^2}} \tan^{-1} \left[\frac{\xi}{(\zeta, \chi)}\right] \sqrt{1-2\zeta\chi+\chi^2}\right\}$$
(23)

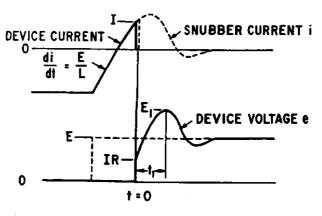


Fig. 2 Idealized Recovery Transient

The average rate of rise of voltage to this peak value is

$$\left(\frac{\mathrm{d}v}{\mathrm{d}t}\right)_{\mathrm{avg}} = \frac{E_1}{t_1} = E_0 \frac{P(\zeta, \chi) \sqrt{1-\zeta^2}}{\tan^{-1} f(\zeta, \chi)}$$

$$= \frac{E^2}{LI} \frac{\chi P(\zeta, \chi) \sqrt{1-\zeta^2}}{\tan^{-1} f(\zeta, \chi)}$$
(25)

Case IA. No damping, \(\zeta = 0

The equations for this special case can be obtained from the general equations for underdamping by setting R, α and ζ equal to zero, while ω becomes ω_{α} .

$$e = E (1 - \cos \omega_{o} t) + \frac{I}{C\omega_{o}} \sin \omega_{o} t$$
 (26)

$$de/dt = E\omega_o \sin \omega_o t + \frac{I}{C} \cos \omega_o t \qquad (27)$$

$$\left(\frac{de}{dt}\right)_{0} = \frac{I}{C} = E\omega_{o}X \tag{28}$$

$$\tan \omega_{0} t_{1} = -\frac{I}{E\omega_{0}C} = -\chi \tag{29}$$

$$t_1 = \frac{\pi - Tan^{-1}\chi}{\omega} \tag{30}$$

$$E_1 = E + \sqrt{E^2 + \left(\frac{I}{\omega_0 C}\right)^2}$$
 (31)

$$p(0, \chi) = \frac{E_1}{E} = 1 + \sqrt{1 + \chi^2}$$
 (32)

$$\left(\frac{dv}{dt}\right)_{avg} = \frac{E_1}{t_1} = E\omega_0 \frac{1 + \sqrt{1 + \chi^2}}{\pi - Tan^{-1}\chi}$$
(33)

$$= \frac{E^2}{LI} = \frac{\chi (1 + \sqrt{1 + \chi^2})}{\pi - Tan^{-1}\chi}$$
 (34)

Case II Over-damped condition, >1

For this condition, the parameter $\boldsymbol{\omega}$ is defined as

$$\omega = \sqrt{\alpha^2 - \omega_0^2} = \omega_0 \sqrt{\zeta^2 - 1}$$
 (35)

Equations (9) and (10) become, respectively

$$e = E - (E - RI)(\cosh \omega t - \frac{\alpha}{\omega} \sinh \omega t) e^{-\alpha^{t}} + \frac{I}{C_{to}} \sinh \omega t \cdot e^{-\alpha^{t}}$$
(36)

de/dt = (E - RI) (20 cosh ax -

$$\frac{\omega^{2} + \alpha^{2}}{\omega} \sinh \omega t \varepsilon^{-\alpha^{t}} + \frac{I}{C}(\cosh \omega t - \frac{\alpha}{\omega} \sinh \omega t) \varepsilon^{-\alpha^{t}}$$
(37)

If condition (16) holds, the peak voltage occurs at a time t₁ obtained by setting (37) equal to zero and solving

$$tanh \omega t_1 = \frac{(E-RI) 2 \alpha + \frac{I}{C}}{(E-RI) \frac{\omega^2 + \alpha^2}{\omega} + \frac{I\alpha}{C\omega}}$$
(38)

$$= \frac{-(2\zeta - 4\zeta^{2}_{x} + \chi)\sqrt{\zeta^{2} - 1}}{1 - 3\zeta_{x} - 2\zeta^{2} + 4\zeta^{3}_{x}}$$
(39)

=
$$g(\zeta,\chi)$$
 (definition of function) (40)

$$c_1 = \frac{\tanh^{-1} g(\zeta_{2X})}{\omega_0 \sqrt{\zeta^2 - 1}}$$
(41)

$$= \frac{\frac{1}{2} \log \left[\frac{1 + g(\zeta, \chi)}{1 - g(\zeta, \chi)} \right]_{if}}{\omega_{o} \sqrt{\zeta^{2} - 1}}$$

$$\left|g(\zeta,\chi)\right| < 1 \tag{42}$$

Substituting t_1 into (36), the same expression as (22) for the peak recovery voltage E_1 is obtained,

The nomalized peak voltage as a function of ζ and χ becomes

$$q(\zeta,\chi) = \frac{E_1}{E} = 1 + \exp\left\{-\frac{\zeta}{\sqrt{\zeta^2 - 1}}, \tan^{-1} g(\zeta,\chi)\right\} \sqrt{1 - 2\zeta\chi + \chi^2}$$
 (43)

The average rate of rise of voltage to this peak value is

$$\left(\frac{dv}{dt}\right)_{avg} = \frac{E_1}{t_1} = E_{CO} \frac{q(\zeta_{JX})\sqrt{\zeta^2 - 1}}{tanh^{-1} g(\zeta_{JX})}$$
(44)

$$= \frac{E^2}{LI} \frac{\chi q(\zeta,\chi) \sqrt{\zeta^2 - 1}}{\tanh^{-1} g(\zeta,\chi)}$$
 (45)

Case III. Critically damped condition, [= 1

For this condition,
$$\alpha = \omega$$
 (46)

$$and\left(\frac{e}{E}\right) = \frac{RI}{E} = 2 \times \tag{47}$$

The inverse transform of (2) yields

$$e = E - (E - RI)(1 - \alpha_t)e^{-\alpha^t}$$

 $+ \frac{1}{2} RI \alpha t e^{-\alpha^t}$ (48)

Differentiating (48)

$$de/dt = \left[E(2 - \alpha t) + \frac{1}{2}RI(\alpha t - 3)\right] \cdot \alpha e^{-\alpha t}$$
(49)

If condition (15) is satisfied (χ < 2/3), the peak voltage is attained at a time t₁ which can be found by setting (49) equal to zero, yielding

$$\alpha t_1 = \frac{2 - \frac{3}{2} \frac{RI}{E}}{1 - \frac{RI}{2E}}$$
 (50)-

$$t_1 = \frac{1}{\omega_0} \cdot \frac{2 - \frac{3}{\lambda}}{1 - \chi} \tag{51}$$

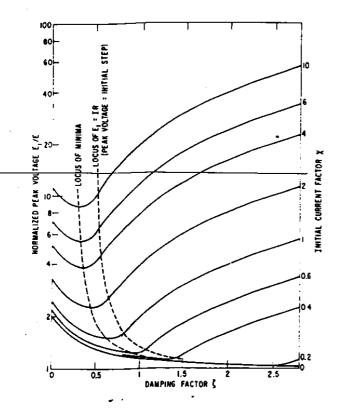


Fig. 3 Peak Voltage as a Function of Damping and Initial Current

Substituting from (50) into (48), the normalized peak recovery voltage is

$$\frac{E_1}{E} = 1 + (1 - \chi) \exp\left(-\frac{2 - 3\chi}{1 - \chi}\right)$$
 (52)

The average rate of rise of voltage to this peak is

$$\left(\frac{d\mathbf{v}}{d\mathbf{t}}\right)_{\text{avg}} = \frac{\mathbf{E}_{1}}{\mathbf{t}_{1}} = \mathbf{E}_{20} \left(\frac{1-\chi}{2-3\chi}\right) \left[1 + (1-\chi)\right],$$

$$\exp\left(-\frac{2-3\chi}{1-\chi}\right) \left[1 + (1-\chi)\exp\left(-\frac{2-3\chi}{2-3\chi}\right)\right] \left[1 + (1-\chi)\exp\left(-\frac{2-3\chi}{1-\chi}\right)\right],$$
(54)

Snubber Circuit Design for Minimum Voltage Spike

The normalized peak voltage E_1/E computed from (23), (43) or (52) is plotted in Fig. 3 as a function of the damping factor ζ , with the initial current factor χ as a parameter. These curves similar to those obtained by Von Zastrow and Galloway from numerical solution of the differential equations of the circuit by computer methods [1]. For a given value χ_0 of the parameter χ_0 , there is a particular value ζ_0 of the parameter χ_0 , there is a particular value ζ_0 of the parameter χ_0 which will minimize the peak voltage ratio $(E_1/E)_0$. Selecting $\zeta = \zeta_0$ represents an optimum snubber design for minimizing the voltage spike with a given capacitance (assuming the inductance L and peak recovery current I are pre-determined), or for minimizing the capacitance required to limit the spike to a specified value. Thus, if $(E_1/E)_0$ is the allowable voltage ratio, the optimum snubber design may be obtained from Fig. 4.

$$\chi_0 = \text{function of } (E_1/E)_0$$
 (55)

$$\zeta_0$$
 = function of $(E_1/E)_0$ (56)

$$c = L \left(\frac{I}{E_{\lambda_0}}\right)^2 \tag{57}$$

$$R = 2 \zeta_0 \frac{L}{C} = 2\zeta_0 E_{X_0} / I$$
 (58)

The average dv/dt, normalized with respect to E ω_{o} is also shown on Fig. 4.

Note that the parameters obtained from Fig. 4 are optimum only if dv/dt is of no consequence, such as may be the case for diodes and reverse voltages on thyristors. However, reverse recovery dv/dt limitations are now appearing in some power device specifications.

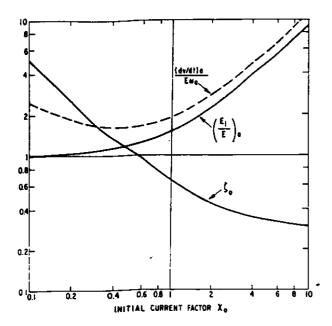


Fig. 4 Optimum Snubber Design Parameters for Minimum Voltage Spike

Snubber Circuit Design for Minimum dv/dt

If the recovering device has a thyristor connected inversely across it, then its reverse recovery dv/dt appears in the forward direction with respect to that thyristor, and becomes critically important. For example, many cycloconverters and reversing d-c motor drives use inverse-parallel

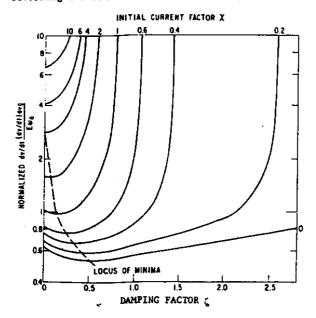


Fig. 5 Average dv/dt as a Function of Damping and Initial Current

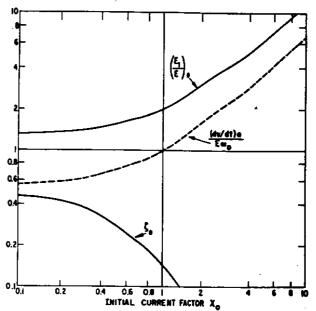


Fig. 6 Optimum Snubber Parameters for Minimum dv/dt

pairs of thyristors. In some inverters, feedback rectifiers are connected directly across the thyristors. Here, the reverse recovery of the rectifier occurs just after commutation of the thyristor, a time when dv/dt is most critical. If the device itself is a bidirectional thyristor (of the triode or diode type), its recovery dv/dt must again be limited.

In discussing dv/dt, the problem of definition arises for all cases except a linear rise at constant slope. For example, the initial slope or the maximum instantaneous slope may be used. Sometimes an exponential rise is assumed for defining or testing purposes. In the ideal case analyzed in the previous sections, where the recovery currentis assumed to "snap" off, the initial dv/dt is theoretically infinite. Therefore, the dv/dt is here defined as the average slope to the voltage peak. The circuit designer and device rating engineer should co-operate in determining that the actual shape of the transient is consistent with preventing the thyristor from self-triggering, which is the main purpose of limiting dv/dt.

The normalized average dv/dt computed from (24), (44) or (53) is plotted in Fig. 5 as a function of the damping factor ζ , with the initial current factor χ as a parameter. It is seen that for a given value χ_0 of the parameter χ , there is a particular choice of damping (ζ_0) which will minimize the average dv/dt at some value (dv/dt)₀. These optimum design parameters are shown in Fig. 6, together with the corresponding peak voltage ratio (E_1/E)₀, from which a snubber may be designed to give a specified dv/dt using minimum capacitance. Note that minimum dv/dt is obtained with less damping than required to minimize the voltage spike.

Compromise Design of Snubber Circuit

In most applications, the peak recovery voltage and dv/dt across a thyristor are both important, and a damping factor selected to compromise between minimum voltage spike and minimum dv/dt is recommended. The set of parameters for that amount of damping which will minimize the product of E_1 and $(dv/dt)_{avg}$ for a given capacitance (still assuming that the inductance L and peak recovery current I are pre-determined by other considerations) are presented in Fig. 7. The product $E_1(dv/dt)$ was chosen as a convenient function for a computer minimization program.

The design procedure is as follows:

- 1. Select a tolerable peak voltage $\mathbf{E_1}$ and calculate $(\mathbf{E_1/E)_o}.$
- 2. From Fig. 7, read the corresponding values of χ_0 , ζ_0 and $(dv/dt)_0/E\omega_0$.
- Calculate C, R, ω₀ and (dv/dt) using (57),
 (58) and (3).

If the resulting value of dv/dt is larger than permissible, a larger capacitance is required and the parameter χ_0 should be selected on the basis of dv/dt limitation. To aid this selection, the optimum dv/dt normalized with respect to the pre-determined factor E^2/LI is plotted in Fig. 8. The procedure is as follows:

For the allowable (dv/dt)_o, calculate (dv/dt);
 LI/E².

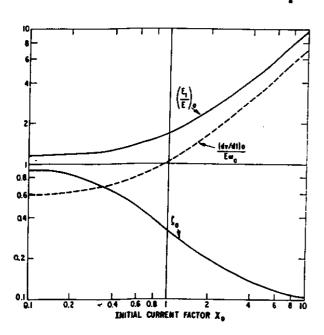


Fig. 7 Optimum Snubber Parameters for Compromise Design

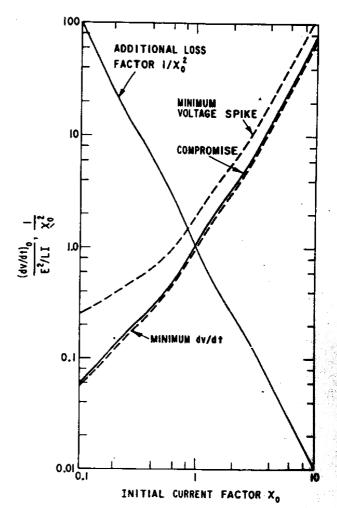


Fig. 8 Optimum dv/dt Factors and Additional Loss
Factor

- 2. From Fig. 8, read the corresponding value of χ_0 , using the "compromise" curve.
- 3. Enter Fig. 7 with this value χ_{0} and read ζ_{0} and $(E_{1}/E)_{0}$.
- Calculate C and R using (57) and (58), and use the nearest standard values.

This compromise design is recommended for most practical applications. In rare cases where the limitations on peak voltage or dv/dt are abnormally stringent, such as to accentuate the importance of one over the other, then Fig. 4 or Fig. 6 and the corresponding curves on Fig. 8 may be used. However, note that there is little improvement in the critical parameter over that given by the compromise design for the same value of $\chi_{\rm O}$.

A plot of a typical recovery transient with a snubber designed for "compromise" damping is shown in Fig. 9, for $\chi=0.6$, $\zeta=0.475$. The thyristor and capacitor voltages are shown; the voltage across the resistor (proportional to current) is the difference between the two curves. The slope of the dashed line in Fig. 9 is the normalized average dv/dt.

For the ideal case where the recovery current is negligible, $\chi \to 0$ and the asymptotes of the "compromise" curves yield

Snubber Losses at Time of Recovery

First, a general expression for the losses in a series L-C-R circuit fed from a d-c source will be obtained in terms of the initial and final state variables. Then, the snubber loss during the recovery transient is obtained as a special case.

Suppose, in the circuit of Fig. 1, that the capacitor voltage changes from V_1 to V_2 and the current changes from I_1 to I_2 in a time interval from t_1 to t_2 . If v is the instantaneous capacitor voltage and i the instantaneous current, they are related by

$$i dt = C dv$$
 (60)

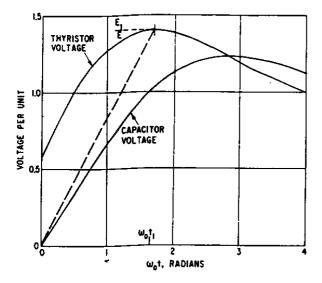


Fig. 9 Typical Recovery Voltage Transient χ = 0.6, ζ = 0.475

The loss W in resistor R may be determined from the energy belance requirement:

Loss = Energy from source - Increase in Energy Stored in Capacitor

> - Increase in Energy Stored in Inductor

$$\int_{t_1}^{t_2} {^{1}}^{2}R dt = E \int_{t_1}^{t_2} i dt - C \int_{V_1}^{V_2} v dv - L \int_{I_1}^{I_2} i di$$

$$W = EC (V_2 - V_1) - \frac{1}{2}C (V_2^2 - V_1^2) - \frac{1}{2}L (I_2^2 - I_1^2)$$

$$= C (V_2 - V_1) \left(E - \frac{V_2 + V_1}{2}\right) - \frac{1}{2}L (I_2^2 - I_1^2)$$
(62)

This is the desired general expression for loss. For the snubber circuit, V_1 = 0, V_2 = E, I_1 = I, I_2 = 0

$$W = \frac{1}{2} CE^2 + \frac{1}{2} LI^2$$
 (64)

$$= \frac{1}{2} L I^2 \left(1 + \frac{1}{x^2} \right)$$
 (65)

Note that all of the energy trapped in the inductance at the time of recovery is inevitably dissipated. The factor $1/\chi^2$, plotted in Fig. 8, represents the per unit additional loss, which is the penalty paid for limiting dv/dt and the voltage spike. Besides the loss at the time of recovery, the snubber will dissipate energy equal to 1/2C (ΔE) any time a step voltage change (ΔE) occurs in the voltage waveform across the device. The losses due to the smoothly-varying portions of the waveform, such as a sinusoidal supply voltage, are generally negligible in comparison with the step losses.

Snubber Loss and Thyristor Dissipation at Time of Turn-on

In particular, when a thyristor turns on from a voltage E, an energy loss 1/2 CE² will occur. Because of the finite voltage fall time of the thyristor, some of this energy will be dissipated in the thyristor instead of the damping resistor, and the capacitor discharge increases the initial di/dt in the thyristor. An estimate of the fraction of the snubber discharge loss that is absorbed by the thyristor can be derived if some simplifying assumption is made regarding the thyristor voltage fall characteristic. For example, suppose that the thyristor voltage falls exponentially with a time constant τ and is independent of the current, then

$$e = E e^{-t/T}$$
 (66)

Note that this exercise is not intended to imply that any actual thyristor has such a characteristic, but only to provide a simple order-of-magnitude loss estimate if the observed fall interval can be approximately fit to such a curve.

The discharge current i of a stubber having a time constant τ_s = RC is given by

$$i = \frac{E}{R} - \frac{\tau_s}{\tau_s - \tau} \left(e^{-t/\tau_s} - e^{-t/\tau} \right)$$
 (67)

The energy W, absorbed by the thyristor is then

$$W_{t} = \int_{0}^{\infty} ei \ dt = \frac{E^{2}}{2R} \frac{\tau_{s} \tau}{\tau_{s} + \tau}$$
 (68)

which is, as a fraction of the total loss

$$\frac{W_{t}}{\frac{1}{2}CE^{2}} = \frac{\tau}{\tau_{s} + \tau} \tag{69}$$

This result simply states that the loss is divided between the thyristor and its snubber in proportion to their respective time constants.

If the rise of load current i in a parallel path through the same thyristor is limited by an inductance L and driven by the voltage (E - e), where the thyristor voltage e is the same assumed exponential fall (66), then

$$\frac{di_L}{dt} = \frac{E - e}{L} = \frac{E}{L} \left(1 - e^{-t/\tau} \right) \tag{70}$$

$$i_{L} = \frac{E}{L} \left[t - \tau \left(1 - e^{-t/\tau} \right) \right]$$
 (71)

The thyristor dissipation produced by this load current rise is

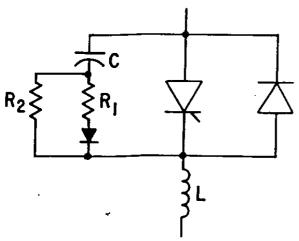


Fig. 10 Forward Polarized Snubber

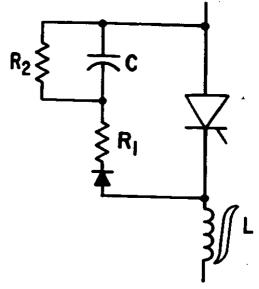


Fig. 11 Reverse Polarized Snubber

$$W_{L} = \int_{0}^{\infty} e_{i_{L}} dt = \frac{E^{2} \tau^{2}}{2L}$$
 (72)

In practice, the rise of load current will not continue indefinitely, but will terminate at some level I_{\perp} . However, equation (72) for the switching loss will be approximately true if the time to reach the current I_{\perp} is several times greater than the time constant τ_{\perp} . If the snubber time constant is much greater than the thyristor fall time $(\tau_{\parallel}>>\tau)$, the ratio of the two contributions to the thyristor switching loss simplifies to

$$\frac{W_{t}}{W_{L}} \approx \frac{L/R}{\tau} \tag{73}$$

When the snubber discharge results in excessive thyristor switching loss W_1 , a polarized snubber arrangement should be considered. Where the primary function of the snubber is to limit the forward dv/dt applied to a thyristor at the time of recovery of an inverse feedback rectifier, the scheme shown in Fig. 10 is often used. The resistor R_1 is the damping resistance effective during forward dv/dt, while R_2 is a much larger resistance to limit the snubber discharge current when the thyristor is fired.

When forward voltage is reapplied to a thyristor as a ramp of relatively low dv/dt, the prime purpose of the snubber is to limit the reverse voltage spike. Here, the arrangement of Fig. 11 can be used to advantage. Damping resistance R₁ is effective during reverse recovery, while resistance R₂ of higher value discharges the snubber capacitor C during the period of forward voltage before the thyristor is fired again.

Note that polarized snubbers do not reduce the circuit losses, but only prevent the losses from being dissipated in the thyristor. For example, a reverse polarized snubber prevents positive charge from being put on the snubber capacitor during the low-loss ramp dv/dt, but the blocked reverse charge is dissipated in the discharge resistor.

When a pair of thyristors are connected in inverse parallel, as in a cycloconverter, the snubber must be effective during recovery of either polarity. Therefore, a polarizing arrangement does not appear to be practical, as indicated in Fig. 12. However, it may be possible to reduce the snubber size by employing non-linear reactors which are unsaturated and have a high value of inductance at the time of recovery when the current is close to zero. Such reactors, shown in Figs. 11 and 12, also reduce the initial di/dt after turn-on [2]. Experience has shown that non-linear reactors cannot be advantageously employed in circuit arrangements of the type shown in Fig. 10.

Conclusions

A procedure for selecting the optimum capacitance and damping resistance for a simple snubber used to limit the recovery transient of power rectifiers or thyristors has been presented. In some circuits, the recovery of one device produces steps of voltage not only across itself but across other devices in the circuit as well. These other devices often have snubbers which contribute to suppression of the transient, and the size of the snubber provided for each device may be reduced. The circuit action during the recovery transient can often, but not always, be represented by an equivalent circuit of the simple form in Fig. 1 [3, 4]. Sometimes, a snubber designed to suppress one transient will not be optimum for suppressing another transient occurring at a different time in the cycle and a compromise must be made. More complex snubber arrangements may also be used, such as the bridge circuit [4].

The energy of the device recovery current trapped in the commutating inductance must be dissipated in the snubber, and the charging of the snubber capacitor by a voltage step causes additional losses as the price of its limiting function. In the typical transient shown in Fig. 9, the additional loss at the time of recovery amounts to 2.78 times the energy 1/2 LI2. When the thyristor is subsequently fixed, the capacitor energy is dissipated, and a considerable fraction of it may be absorbed by the thyristor if the snubber is not polarized. If the turn-on voltage is the same as the commutating voltage, the discharge loss is also 2.78 times the trapped recovery energy. Thus, the need to dissipate recovery energy requires a total additional dissipation of about six times that recovery energy. For high frequency operation, the need for devices having a small recovery current and high dv/dt capability as well as high di/dt capability becomes apparent.

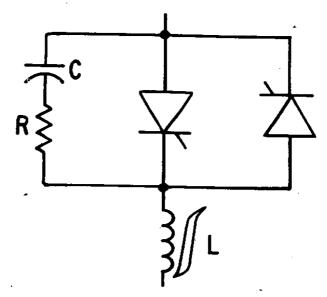


Fig. 12 Unpolarized Snubber

References

- E. E. VonZastrow and J. H. Galloway, "Commutation Behaviour of Diffused High Current Rectifier Diodes", IEEE International Convention Record, 1964, Part 4, p. 106. (Also available as GE-SPD Application Note 200.42, June 1965.)
- D. A. Paice and P. Wood, "Nonlinear Reactors as Protective Elements for Thyristor Circuits," IEEE Trans. on Magnetics, Vol. MAG-3, No. 3, Sept. 1967, pp. 228-232.
- J. B. Rice and L. E. Nickels, "Commutation dv/dt Effects in Thyristor Three-Phase Bridge Converters," IEEE Trans. on Industry and General Applications," Vol. IGA-4, No. 6, Nov./Dec 1968, pp. 665-672.
- G. Thiele, "Richtlinien für die Bemessung der Trägerspeichereffekt-Beschaltung von Thyristoren" (Guiding Principles for the Design of Carrier-Storage Effect Connections for Thyristors), ETZ-A Vol. 90, No. 14, 1969, pp. 347-352.

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